# 5. Pinning information

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	4	А <del>     </del> К
2	Α	anode		G sym037
3	G	gate		symosi
4	А	mb; connected to anode	☐1 ☐2 ☐3 SC-73 (SOT223)	

# 6. Ordering information

### **Table 3. Ordering information**

Type number	Package			
	Name	Description	Version	
NCR100W-10L	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223	

## 7. Marking

### **Table 4. Marking codes**

Type number	Marking code
NCR100W-10L	10010L

# 8. Limiting values

## **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage		-	850	V
$V_{RRM}$	repetitive peak reverse voltage		-	850	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>sp</sub> ≤ 98 °C	-	0.8	Α
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; $T_{sp} \le 98 \text{ °C}$ ; Fig. 1; Fig. 2; Fig. 3	-	1.1	А
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 ^{\circ}C$ ; $t_p = 10  ms$ ; Fig. 4; Fig. 5	-	11	А
		half sine wave; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 8.3 ms	-	12.1	Α
I <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; SIN	-	0.605	A²s
dl <sub>T</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 0.1 mA	-	50	A/µs
I <sub>GM</sub>	peak gate current		-	1	Α
$V_{RGM}$	peak reverse gate voltage		-	5	V
$P_{GM}$	peak gate power		-	2	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	-	0.1	W
T <sub>stg</sub>	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C

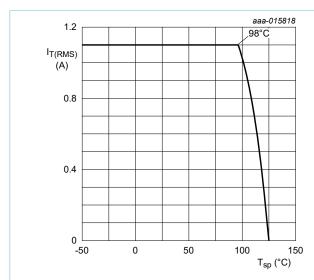


Fig. 1. RMS on-state current as a function of solder point temperature; maximum values

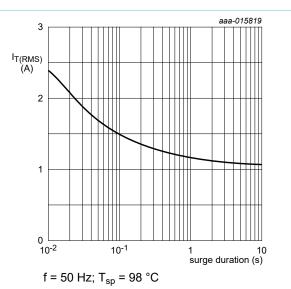


Fig. 2. RMS on-state current as a function of surge duration; maximum values

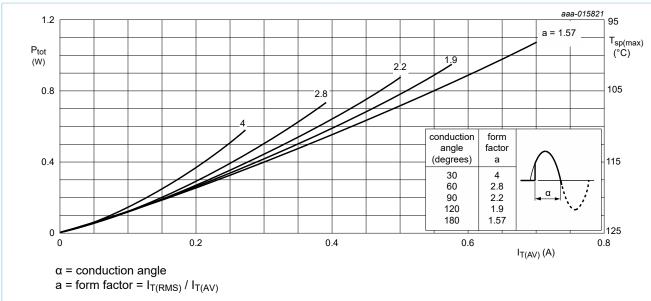


Fig. 3. Total power dissipation as a function of RMS on-state current; maximum values

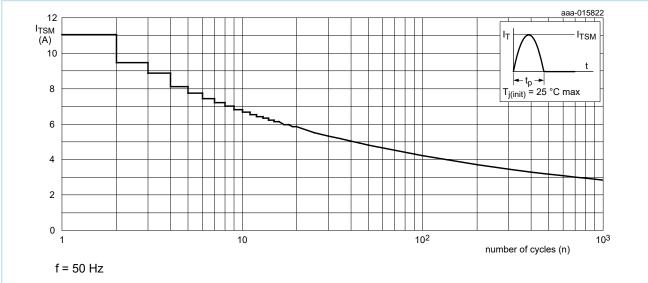
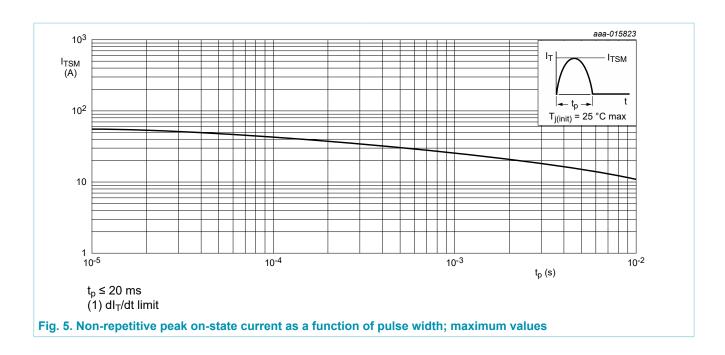


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

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### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point	half cycle; Fig. 6	-	-	25	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air	printed circuit board mounted; minimum footprint; in free air	-	130	-	K/W

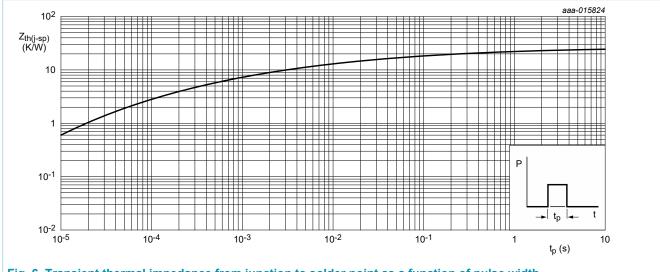


Fig. 6. Transient thermal impedance from junction to solder point as a function of pulse width

### 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	racteristics		'	1		
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 \text{ °C};$ Fig. 7	15	-	50	μA
ار	latching current	$V_D$ = 12 V; $I_G$ = 0.5 mA; $T_j$ = 25 °C; $R_{GK(ext)}$ = 1 k $\Omega$ ; Fig. 8	-	-	6	mA
I <sub>H</sub>	holding current	$V_D = 12 \text{ V}; T_j = 25 \text{ °C}; R_{GK(ext)} = 1 \text{ k}\Omega;$ Fig. 9	-	-	3	mA
$V_{T}$	on-state voltage	I <sub>T</sub> = 1.2 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	1.25	1.7	V
V <sub>GT</sub>	gate trigger voltage	$V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 \text{ °C};$ Fig. 11	-	0.5	0.8	V
		$V_D$ = 850 V; $I_T$ = 10 mA; $T_j$ = 125 °C; Fig. 11	0.3	0.5	-	V
I <sub>D</sub>	off-state current	$V_D = 850 \text{ V}; R_{GK(ext)} = 1 \text{ k}\Omega; T_j = 125 °C$	-	0.05	1	mA
I <sub>R</sub>	reverse current	$V_R = 850 \text{ V}; T_j = 125 \text{ °C}; R_{GK(ext)} = 1 \text{ k}\Omega$	-	0.05	1	mA
Dynamic c	harateristics					,
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 569 V; $T_j$ = 125 °C; $R_{GK}$ = 1 k $\Omega$ ; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform	100	-	-	V/µs
t <sub>gt</sub>	gate-controlled turn-on time	$I_{TM}$ = 2 A; $V_D$ = 850 V; $I_G$ = 10 mA; $dI_G/dt$ = 0.1 A/µs; $T_j$ = 25 °C	-	2	-	μs
t <sub>q</sub>	commutated turn-off time	$V_{DM}$ = 569 V; $T_j$ = 125 °C; $I_{TM}$ = 1.6 A; $V_R$ = 35 V; $(dI_T/dt)_M$ = 30 A/ $\mu$ s; $dV_D/dt$ = 2 V/ $\mu$ s; $R_{GK(ext)}$ = 1 k $\Omega$ ; $(V_{DM}$ = 67% of $V_{DRM})$	-	100	-	μs

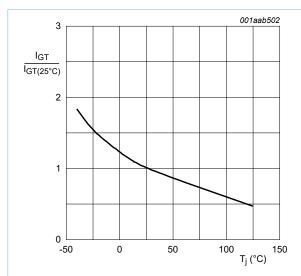


Fig. 7. Normalized gate trigger current as a function of junction temperature

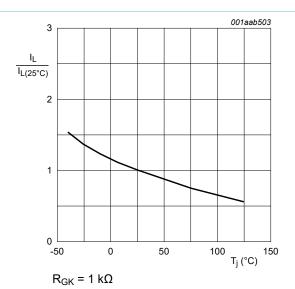


Fig. 8. Normalized latching current as a function of junction temperature

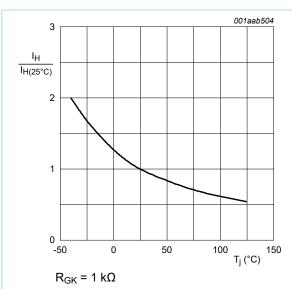
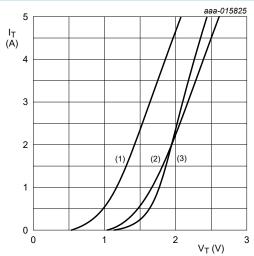


Fig. 9. Normalized holding current as a function of junction temperature



 $V_{o}$  = 1.173 V;  $R_{s}$  = 0.216  $\Omega$ 

(1)  $T_j = 125$  °C; typical values (2)  $T_j = 125$  °C; maximum values

(3)  $T_j = 25$  °C; maximum values

Fig. 10. On-state current as a function of on-state voltage

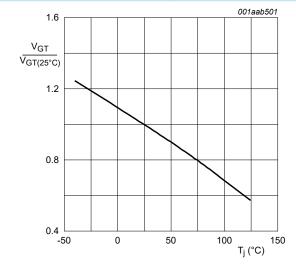


Fig. 11. Normalized gate trigger voltage as a function of junction temperature

## 11. Package outline

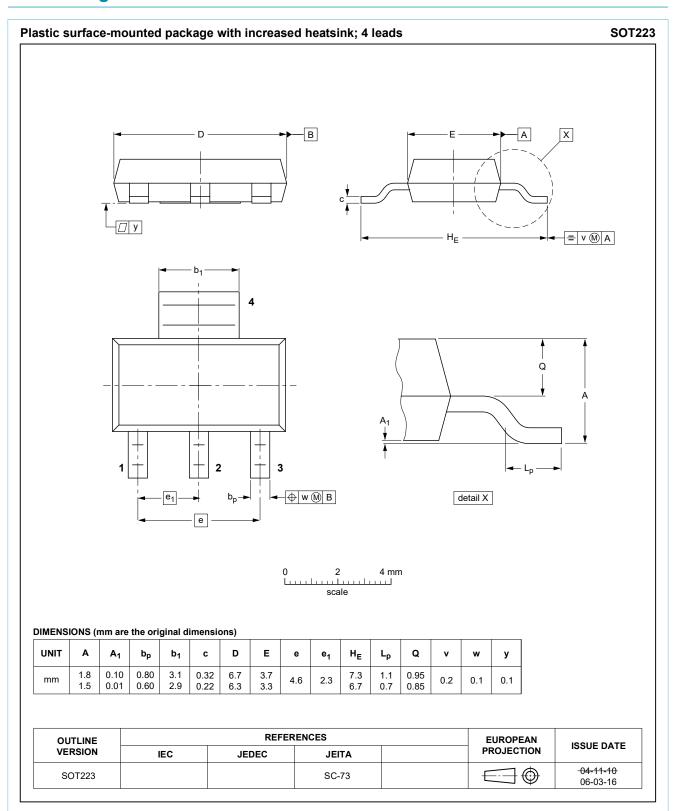
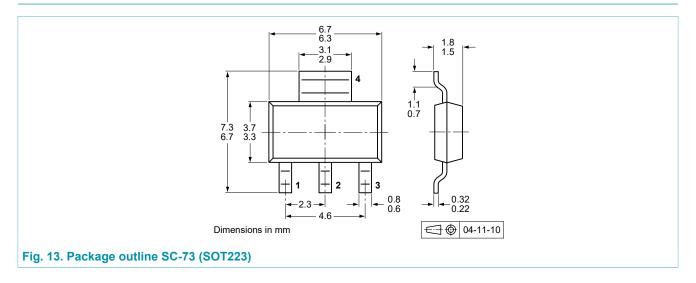
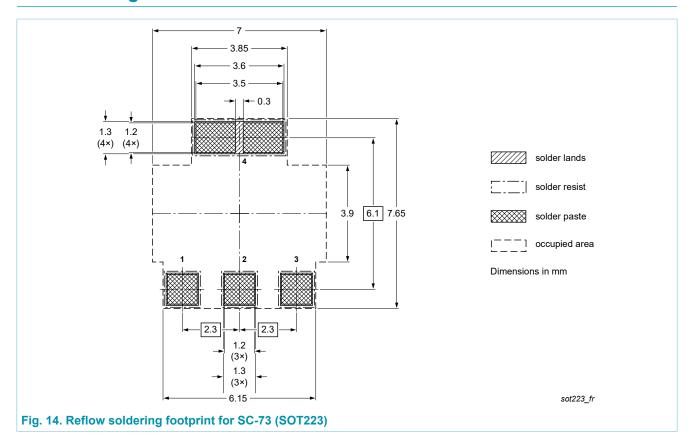


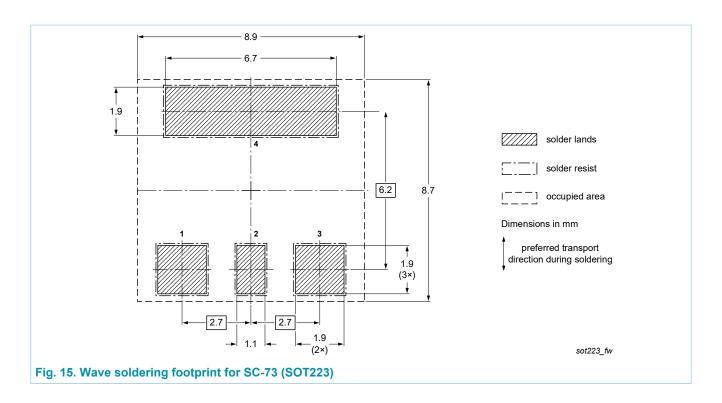
Fig. 12. Package outline SC-73 (SOT223)

## 12. Package outline (minimized)



## 13. Soldering





## 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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